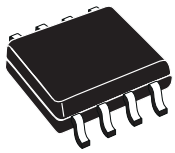
L6375S

0.5A high-side driver industrial intelligent power switch

Preliminary Data

Features

- 0.5A output current
- 8V to 35V supply voltage range
- Internal current limiting
- Thermal shutdown
- Open ground protection
- Internal negative voltage clamping for fast demagnetization
- Differential inputs with large common mode range and threshold hysteresis
- Undervoltage lockout with hysteresis
- Open load detection
- Two diagnostic outputs
- Output status LED driver
- Non dissipative short circuit protection
- Immunity against burst transient (IEC 61000-4-4)
- ESD protection (human body model ±2kV)



SO-8

Description

The L6375S is a monolithic Intelligent Power Switch in Multipower BCD Technology, for driving inductive or resistive loads with controlled output voltage slew rate and short circuit protection.

An internal Clamping Diode enables the fast demagnetization of inductive loads. Diagnostic for CPU feedback and extensive use of electrical protections make this device extremely rugged and specially suitable for industrial automation applications.

Table 1. Device summary

Order codes	Op. temp. range, °C	Package	Packaging
L6375S	-25 to +125	SO-8	Tube
L6375STR	-25 to +125	SO-8	Tape & Reel

Contents

1 Block diagram and pin description

Figure 1. Block diagram

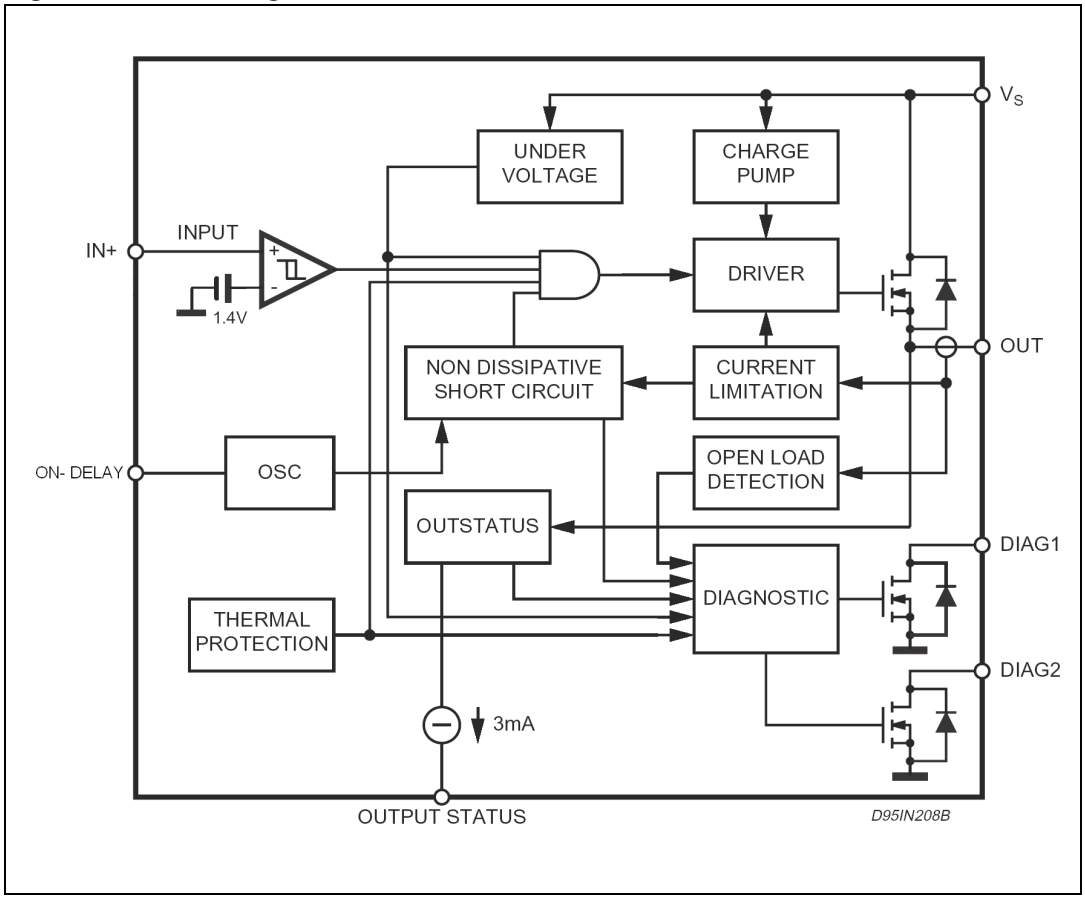
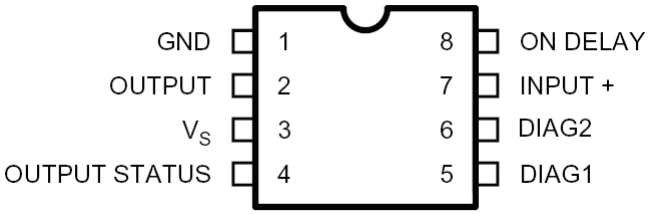


Figure 2. Pin connection (top view)



SO-8

1.1 Pin description

Table 2. Pin description

Pin N°	Pin name	Function
1	GND	Ground
2	OUT	High Side output with built-in current limitation
3	V_S	Supply Voltage Input, the value of the supply voltage is monitored to detect under voltage condition
4	Output status	This current source output is capable of driving a LED to signal the status of the output pin. The pin is active (source current) when the output pin is considered high (See *Figure 4*)
5	DIAG1	DIAGNOSTIC 1 output. This open drain reports the IC working conditions. (See Diagnostic truth *Table 6*)
6	DIAG2	DIAGNOSTIC 2 output. This open drain reports the IC working conditions. (See Diagnostic truth *Table 6*)
7	IN+	Comparator inverting input
8	ON-DELAY	Programmable ON time interval duration during short circuit operation

2 Electrical specifications

2.1 Absolute maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_S	Supply voltage (tw < 10 ms)	50	V
V_S	Supply voltage (DC)	40	V
V_S -V_{out}	Supply to output differential voltage	internally limited	V
V_{od}	Externally forced voltage	-0.3 to 7	V
I_{od}	Externally forced current	±1	mA
I_{out}	Output current (see also Isc)	internally limited	A
V_{out}	Output voltage	internally limited	V
P_{TOT}	Power dissipation	internally limited	W
V_{diag}	External voltage	-0.3 to 40	V
I_{diag}	Externally forced current	-10 to 10	mA
I_i	Input current	20	mA
V_i	Input voltage	-10 to Vs +0.3	V
T_{op}	Ambient temperature, operating range	-25 to 85	°C
T_J	Junction temperature, operating range (see Overtemperature Protection)	-25 to 125	°C
T_{STG}	Storage temperature	-55 to 150	°C
E_I	Energy inductive load T_J = 85°C	200	mJ

2.2 Thermal data

Table 4. Thermal data

Symbol	Parameter		Value	Unit
R_{thJA}	Thermal resistance junction-ambient	Max	100(1)	°C/W
R_{thJP}	Thermal resistance junction-pins	Max	15	°C/W

1. When mounted on a standard single-sided FR-4 board with 0.5 cm^2 of Cu (at least 35µm) thick connected to all V_{CC} pins. Horizontal mounting and no artificial air flow.

2.3 Electrical characteristics

Table 5. Electrical characteristics
(V_S = 24V; T_J = –25 to +125°C, unless otherwise specified)

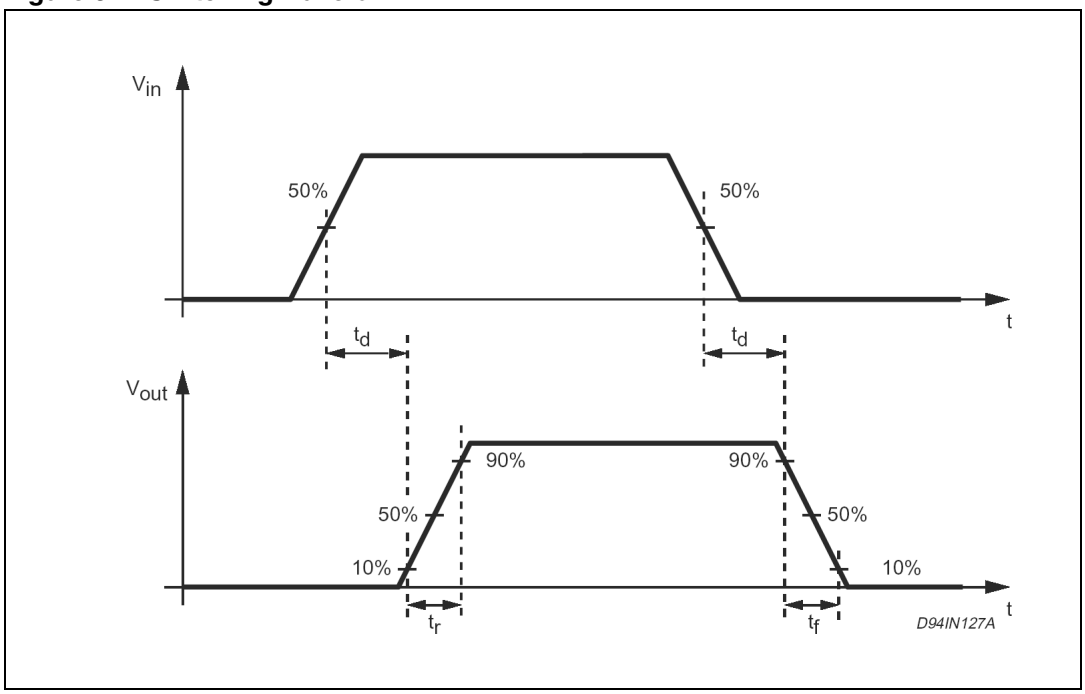
Symbol	Parameter	Test condition	Min	Typ	Max	Unit
V_{smin}	Supply voltage for valid diagnostic	Idiag = > 0.5mA; Vdiag = 1.5V;	4		35	V
Vs	Operative supply voltage		8	24	35	V
V_{sth1}	Undervoltage threshold 1		7	7.5	8	V
V_{sth2}	Undervoltage threshold 2		6.5	7	7.5	V
V_{shys}	Under voltage hysteresis		300	500	700	mV
I_q	Quiescent current	Output open		800		µA
I_{qo}	Quiescent current	Output ON		1.6		mA
V_{ith}	Input threshold voltage		0.8	1.3	2	V
V_{iths}	Input threshold hysteresis		50		400	mV
V_{il}	Input low level voltage		-7		0.8	V
V_{ih}	Input high level voltage	V_s < 18V	2		V_s - 3	V
V_{ih}	Input high level voltage	V_s > 18V	2		15	V
I_{ib}	Input bias current	V_i = -7 to 15V	-250		250	mA
I_{dch}	Delay capacitor charging current	ON DELAY pin shorted to Ground		2.5		mA
V_{don}	Output voltage drop	Iout = 500mA T_J = 25°C T_J = 125°C Iout =625mA T_J = 25°C T_J= 125°C		200 320 250 400	280 440 350 550	mV mV mV mV
I_{olk}	Output leakage current	V_i = LOW; Vout=0			100	µA
V_{ol}	Output low state voltage	V_i = HIGH; pin floating		0.8	1.5	V
V_{cl}	Internal voltage clamp (Vs-Vout)	I_o = 200mA single pulsed = 300ms	48	53	58	V
I_{sc}	Short circuit output current	V_s = 8 to 35V; R_l = 2Ω;	0.75	1.1	1.5	A
I_{old}	Open load detection current	V_i = V_{ih}; T_A= 0 to +85°C	1	3	6	mA
V_{oth1}	Output status threshold 1 voltage		4.5	5	5.5	V
V_{oth2}	Output status threshold 2 voltage		4	4.5	5	V
V_{ohys}	Output status threshold hysteresis		300	500	700	mV
I_{osd}	Output status source current	Vout > Voth1 ; Vos = 2.5V	2		4	mA

Table 5. Electrical characteristics (continued)
(V_S = 24V; T_J = –25 to +125°C, unless otherwise specified)

Symbol	Parameter	Test condition	Min	Typ	Max	Unit
V_{osd}	Active output status driver drop voltage	$V_S - V_{OS}$; I_{OS} = 2mA T_A = 0 to +85°C		1.5	3	V
I_{oslk}	Output status driver leakage current	$V_{out} < V_{oth2}$; V_{os} = 0V V_S = 18 to 35V			25	mA
V_{dgl}	Diagnostic drop voltage	D1 / D2 = L ; I_{diag} = 0.5mA D1 / D2 = L ; I_{diag} = 3mA		40 250		mV mV
I_{dglk}	Diagnostic leakage current	D1 / D2 = H ; 0 < V_{dg} < V_s V_S = 15.6 to 35V			5	µA
T_{max}	Over temperature upper threshold			150		°C
T_{hys}	Over temperature hysteresis			20		°C
AC operation (pin numbering referred to Minidip package)						
t_r -t_r	Rise or fall time	V_s = 24V; R_l =70Ω R_l to ground		20		µs
t_d	Delay time	V_s = 24V; R_l =70Ω R_l to ground		5		µs
dV/dt	Slew rate (rise and fall edge)		7	1	15	V/µs
t_{ON}	On time during short circuit condition	50pF < C_{DON}< 2nF		1.28		µs/pF
t_{OFF}	Off time during short circuit condition			64		t_{ON}
f_{max}	Maximum operating frequency			25		KHz
Source drain NDMOS diode						
V_f	Forward on voltage	@ Ifsd = 625mA		1	1.5	V
I_{fD}	Forward peak voltage	t = 10ms; d = 20%			2	A
t_{rr}	Reverse recovery time	If= 625mA di/dt = 25A/ms		200		ns
t_{fr}	Forward recovery time			50		ns

2.4 Switching waveform

Figure 3. Switching waveform



2.5 Input section

An Single ended Input TTL/CMOS compatible with wide voltage range and high noise immunity (thanks to a built in hysteresis) is available.

2.6 Over temperature protection (OVT)

An on-chip Over Temperature Protection provides an excellent protection of the device in extreme conditions. Whenever the temperature - measured on a central portion of the chip exceeds T_{max} = 150°C (typical value) the device is shut off, and the DIAG2 output goes LOW. Normal operation is resumed as the chip temperature (normally after few seconds) falls below T_{max} - T_{hys} = 130°C (typical value). The hysteresis avoid that is an intermittent behavior take place.

2.7 Under voltage protection (UV)

The supply voltage is expected to range from 8 to 35V. In this range the device operates correctly. To avoid any misfunctioning the supply voltage is continuously monitored to provide an under voltage protection. As V_s falls below V_{sth}-V_{shys} (typically 7.5 V, see fig.1) the output power MOS is switched off and DIAG1 and DIAG2 (see Diagnostic truth table). Normal operation is resumed as soon as Vs exceeds Vsth. The hysteretic behavior prevents intermittent operation at low supply voltage.

2.8 Over current operation

In order to implement a short circuit protection the output power MOS is driven in linear mode to limit the output current to the I_{sc} (1.1A typical value). This condition (current limited to the Isc value) lasts for a Ton time interval, that can be set by means of a capacitor (C_{don}) connected to the ON DELAY pin according to the following formula:

T_{on} = 1.28 µsec/pF

for

50pF< C_{don} < 2nF

After the T_{on} interval has expired the output power MOS is switched off for the T_{off} time interval with:

$T_{off} = 64 \cdot T_{on}$.

When also the Toff interval has expired, the out-put power MOS is switched ON. At this point in time two conditions may occur

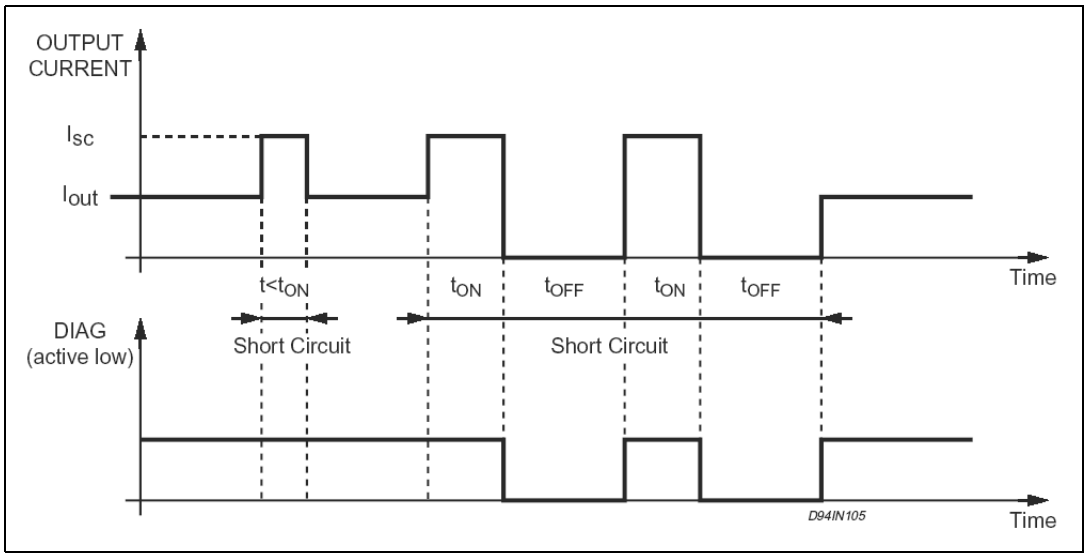
a) The overloads still present, and then the output power MOS is again driven in linear mode (limiting the output current to I_{SC}) for another T_{ON}, starting a new cycle, or

b) the over load the overload condition is removed, and the output power MOS is no longer driven in linear mode. All these occurrences are presented on the DIAG2 pin (see fig 2).

We call this unique feature Non Dissipative Short Circuit Protection and it ensures a very safe operation even in permanent overload conditions. Note that choosing the most appropriate value for the Ton interval (i.e. the value of the Cdon capacitor) a delay (the Ton itself) will prevent that a misleading Short Circuit information is presented on the DIAG2 output, when driving capacitive loads (that acts like short circuit in the very beginning)

or Incandescent Lamp (a cold filament has a very low resistive value). The Non Dissipative Short Circuit Protection can be disabled (keeping Ton = 0 but with the output current still limited to Isc, and Diagnostic disabled) simply shorting to ground the ON DELAY pin.

Figure 4. Non dissipative short circuit protection operation



2.9 Diagnostic logic

The operating conditions of the device are permanently monitored and the following occurrences are signalled via the DIAG1/DIAG2 open-drain output pins see diagnostic Truth Table.

- Short Circuit versus ground.
- Short Circuit versus VS.
- Under Voltage (UV)
- Over Temperature (OVT)
- Open Load, if the output current is less than 3mA (typical value).

2.10 Demagnetization of inductive loads

An internal zener diode, limiting the voltage across the Power MOS to between 50 and 60V (Vcl), provides safe and fast demagnetization of inductive loads without external clamping devices. The maximum energy that can be absorbed from an inductive load is specified as 200mJ (at T_J = 85°C)

2.11 Diagnostic truth table

Table 6. Diagnostic truth table

Diagnostic conditions	Input	Output	Diag1	Diag2
Normal Operation	L H	L H	H H	H H
Open Load Condition (I_o< I_{old})	L H	L H	H L	H H
Short to V_S	L H	H H	L L	H H
Short Circuit to Ground (I_O = I_{SC}) (1) (pin ON-DELAY grounded)	H L	X L	H H	H H
Output DMOS Open	L H	L L	H L	H H
Overtemperature	L H	L L	H H	L L
Supply Undervoltage (V_S< V_{sth2})	L H	L L	L L	L L

1. A cold lamp filament, or a capacitive load may activate the current limiting circuit of the IPS, when the IPS is initially turned on.

3 Application circuits

Figure 5. Inductive load equivalent circuit

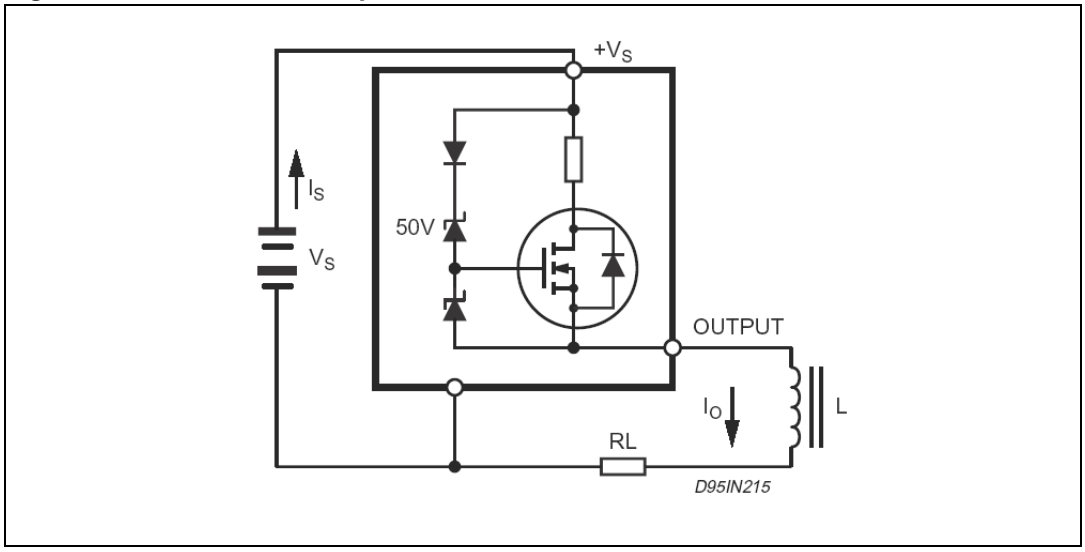


Figure 6. External demagnetisation circuit (versus ground)

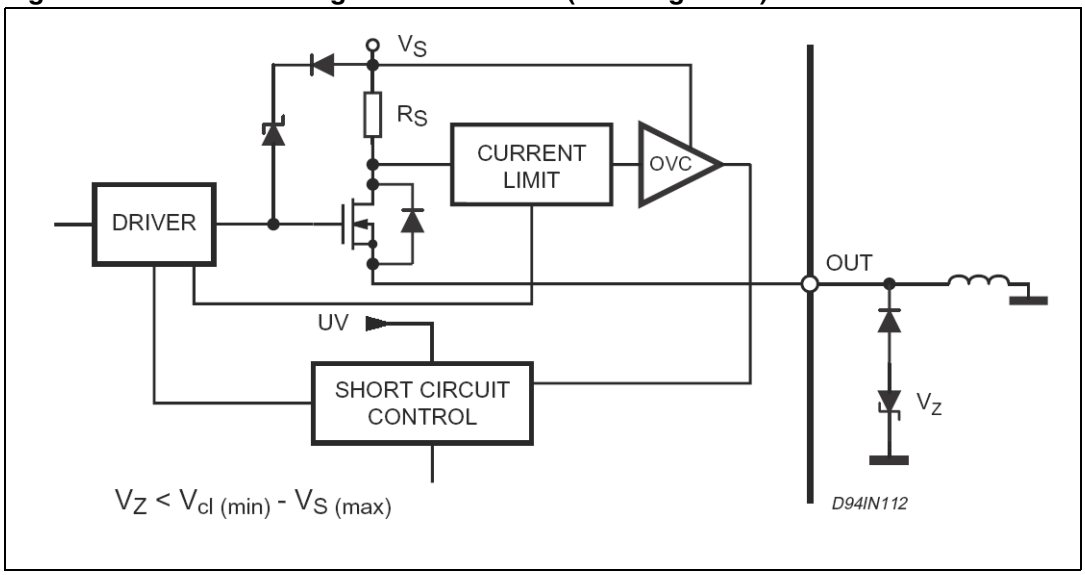


Figure 7. External demagnetisation circuit (versus vs)

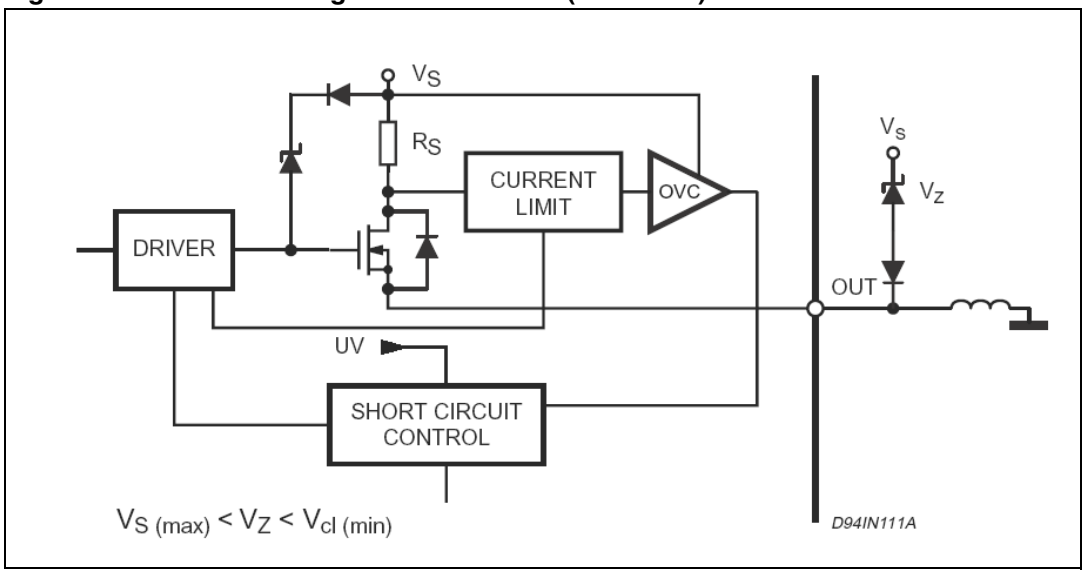
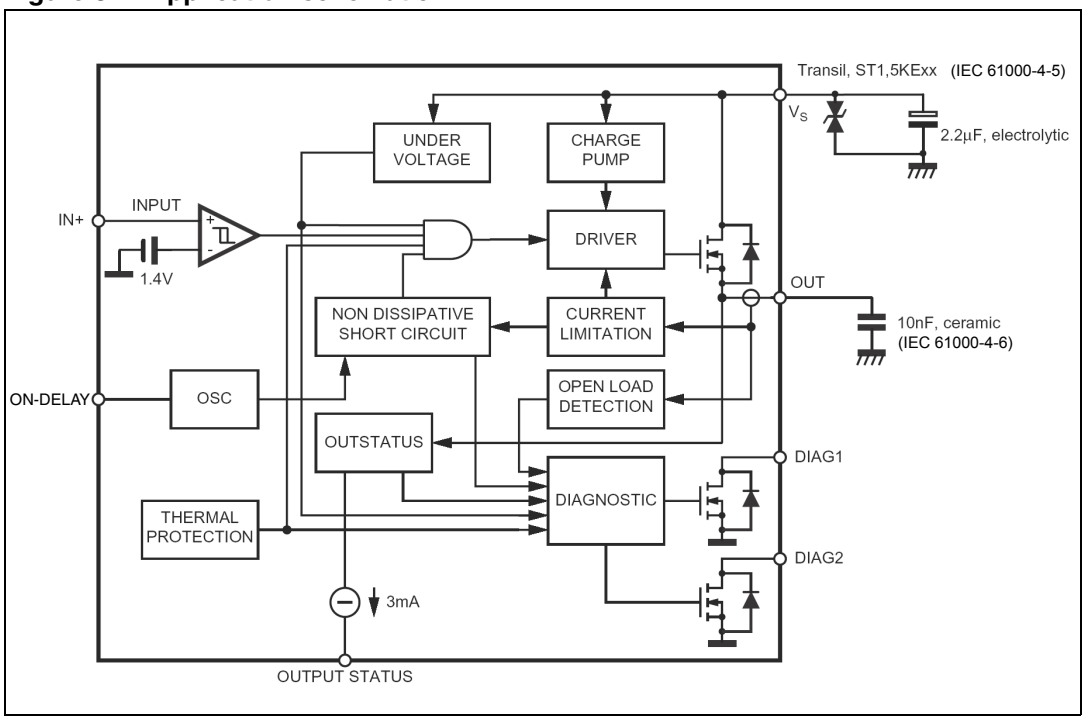


Figure 8. Application schematic



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Table 7. SO-8 mechanical data

Dim.	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1	45 (typ.)					
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S	8º (max.)					

Figure 9. Package dimensions

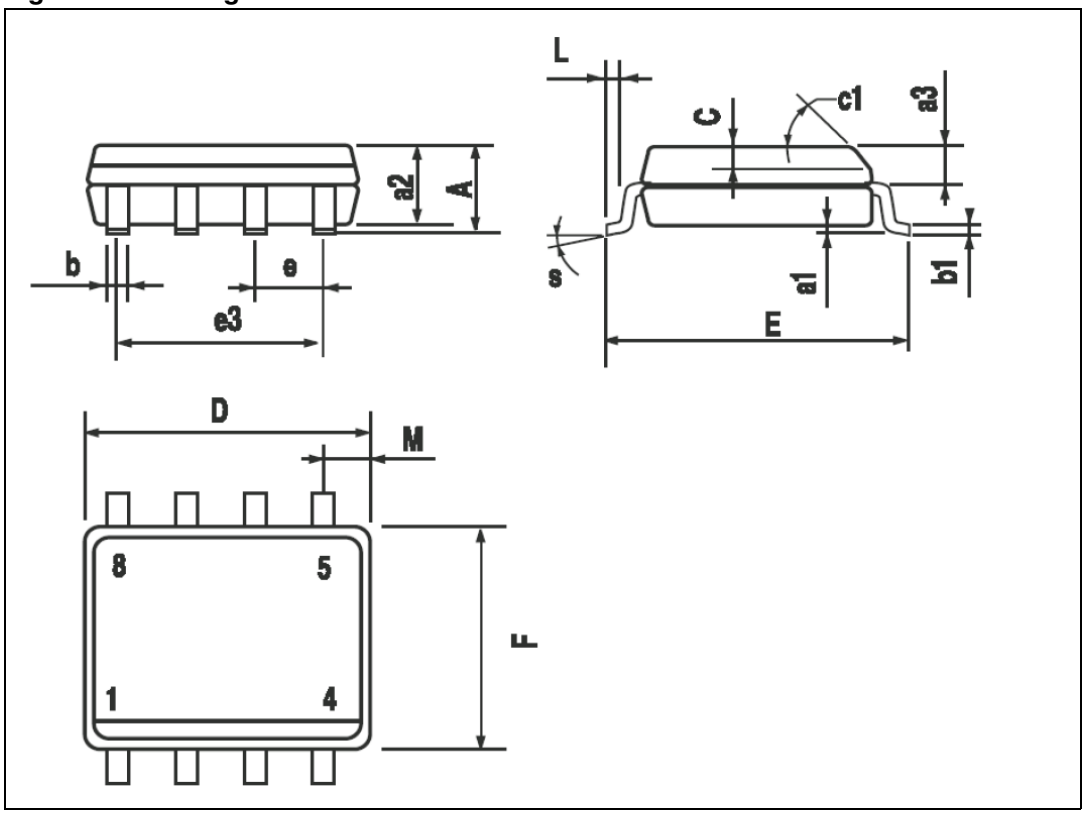
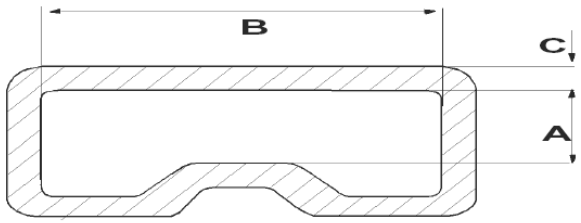
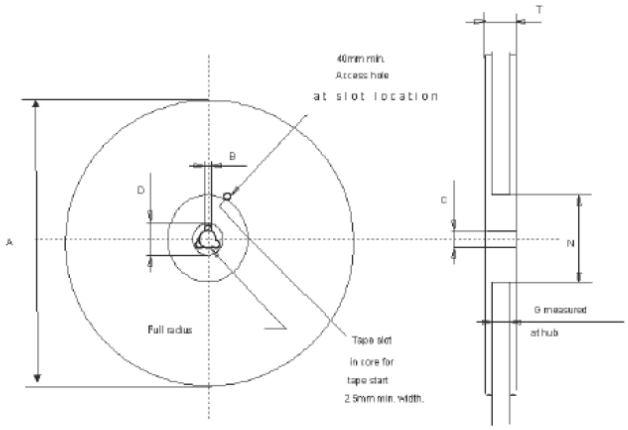


Figure 10. SO-8 Tape and reel information



Base Q.ty	100
Bulk Q.ty	2000
Tube Length(± 0.5)	532
A	3.2
B	6
C(± 0.1)	0.6



Reel Dimension

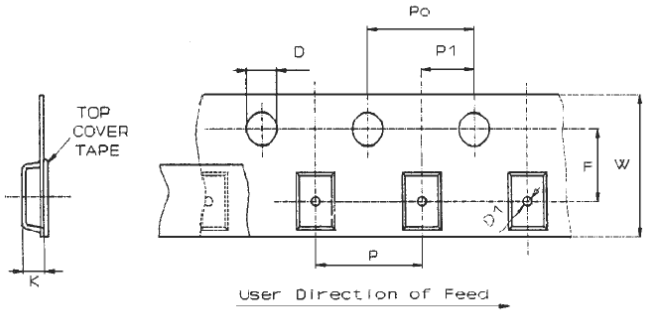
Base Q.ty	2500
Bulk Q.ty	2500
A(Max)	330
B(Min)	1.5
C(± 0.2)	13
F	20.2
G(+2/-0)	12.4
N(Min)	60
T(Max)	18.4

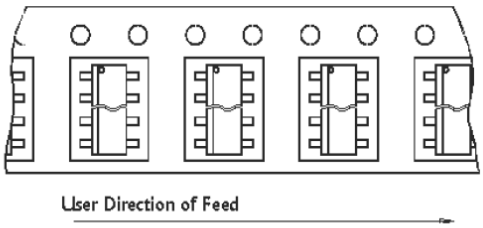
Tape Dimension

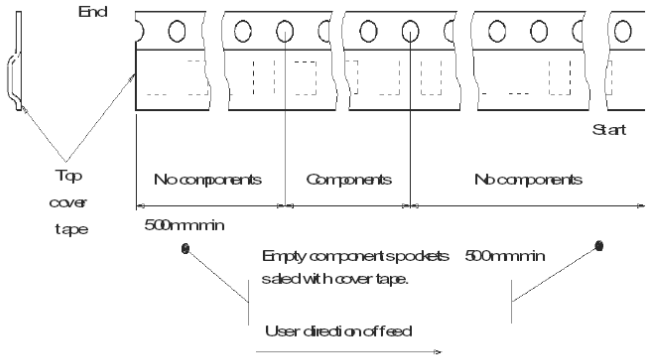
According to Electronic Industries Association(EIA) Standard 481 rev. A, Feb 1986

Tape Width	W	12
Tape Hole Spacing	P0 (± 0.1)	4
Component Spacing	P	8
Hole Diameter	D(± 0.2/-0)	1.5
Hole Diameter	D1(Min)	1.5
Hole Position	F(± 0.05)	5.5
Compartament Depth	K(Max)	4.5
Hole Spacing	P1(± 0.1)	2

All dimension are in mm.







5 Revision history

Table 8. Revision history

Date	Revision	Changes
18-Sep-2006	1	Initial release
19-Jun-2007	2	Truth table updated
05-Jul-2007	3	Typo in *Table 5 on page 6*
16-Jul-2007	4	Pin out updated
15-Oct-2007	5	Updated *Table 4 on page 5*

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